## FAIRCHILD SEMICONDUCTOR FDD6692/FDU6692

## 30V N-Channel PowerTrench<sup>®</sup> MOSFET

### **General Description**

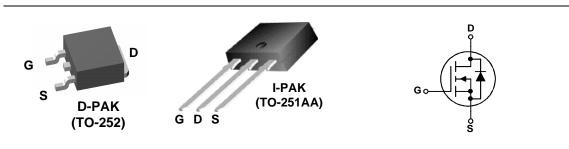
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low RDS(ON) and fast switching speed.

### Applications

- DC/DC converter
- Motor drives

### Features

- 54 A, 30 V.  $R_{DS(ON)} = 12 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$  $R_{DS(ON)} = 14.5 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
- Low gate charge (18 nC typical)
- Fast switching
- + High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$



### Absolute Maximum Ratings T\_=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		30	V
V <sub>GSS</sub>	Gate-Source Voltage		±16	V
ID	Drain Current – Continuous	(Note 3)	54	A
	- Pulsed	(Note 1a)	162	
PD	Power Dissipation for Single Operation	(Note 1)	57	W
		(Note 1a)	3.8	
		(Note 1b)	1.6	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +175	°C

### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	2.6	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

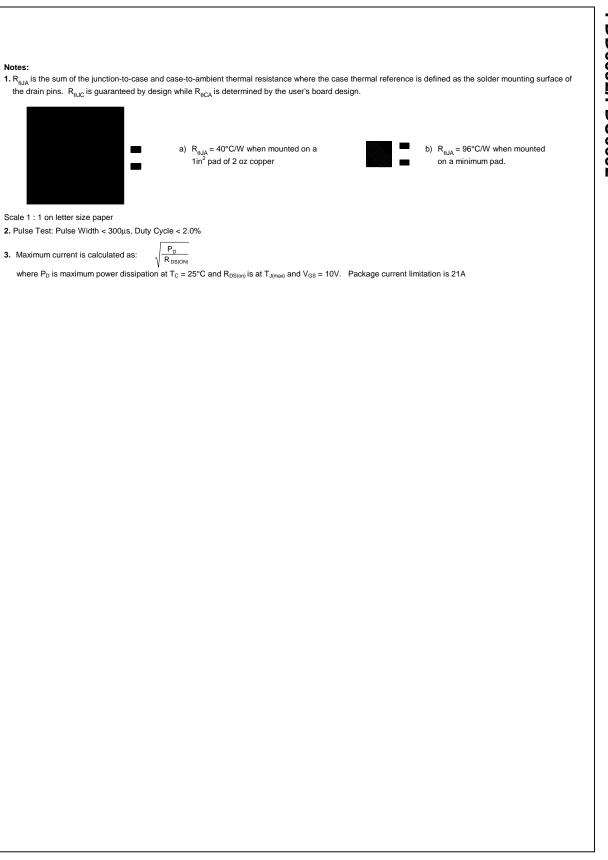
### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape width	Quantity
FDD6692	FDD6692	D-PAK (TO-252)	13"	12mm	2500 units
FDU6692	FDU6692	I-PAK (TO-251)	Tube	N/A	75

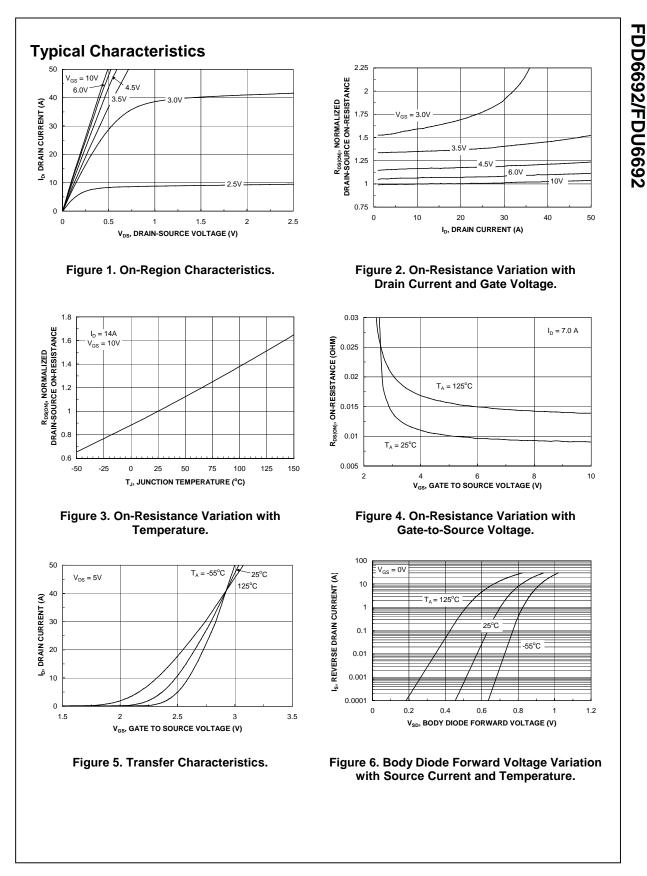
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	ource Avalanche Ratings (Note	2)			1	L
W <sub>DSS</sub>	Drain-Source Avalanche Energy	Single Pulse, $V_{DD} = 15 \text{ V}$ , $I_D = 14 \text{ A}$			165	mJ
I <sub>AR</sub>	Drain-Source Avalanche Current				14	А
Off Char	racteristics		•	•		
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V
ΔBV <sub>DSS</sub> ΔTJ	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		26		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, \qquad V_{GS} = 0 \text{ V}$			1	μA
IGSSF	Gate-Body Leakage, Forward	$V_{GS} = 16 V$ , $V_{DS} = 0 V$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -16 \text{ V},  V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1	1.6	3	V
$\Delta V_{GS(th)}$ $\Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		-5		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance			9.5 11.5 16.5	12 14.5 18	mΩ
D(on)	On–State Drain Current	$V_{GS} = 10 \text{ V},  V_{DS} = 5 \text{ V}$	50			А
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 V$ , $I_{D} = 14 A$		54		S
	c Characteristics	L			1	
	Input Capacitance	$V_{DS} = 15 V$ , $V_{GS} = 0 V$ ,		2164		pF
	Output Capacitance	$v_{DS} = 15 v$ , $v_{GS} = 0 v$ , f = 1.0 MHz		357		pF
Crss	Reverse Transfer Capacitance	1		138		pF
	Turn-On Delay Time	$V_{DD} = 15 V$ , $I_D = 1 A$ ,		9	18	ns
t <sub>d(on)</sub> t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = 10 \text{ V},  R_{GEN} = 6 \Omega$		5	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	-		35	56	ns
t <sub>f</sub>	Turn-Off Fall Time	-		10	20	ns
Q <sub>q</sub>	Total Gate Charge	$V_{DS} = 15 \text{ V}, \qquad I_D = 14 \text{ A},$		18	25	nC
Q <sub>gs</sub>	Gate–Source Charge	$V_{GS} = 5 V$		5		nC
Q <sub>gd</sub>	Gate–Drain Charge			5		nC
	ource Diode Characteristics	and Maximum Patings				
l <sub>s</sub>	Maximum Continuous Drain–Source				3.2	А
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \text{ V},  I_S = 3.2 \text{ A}  (\text{Note 2})$		0.72	1.2	V

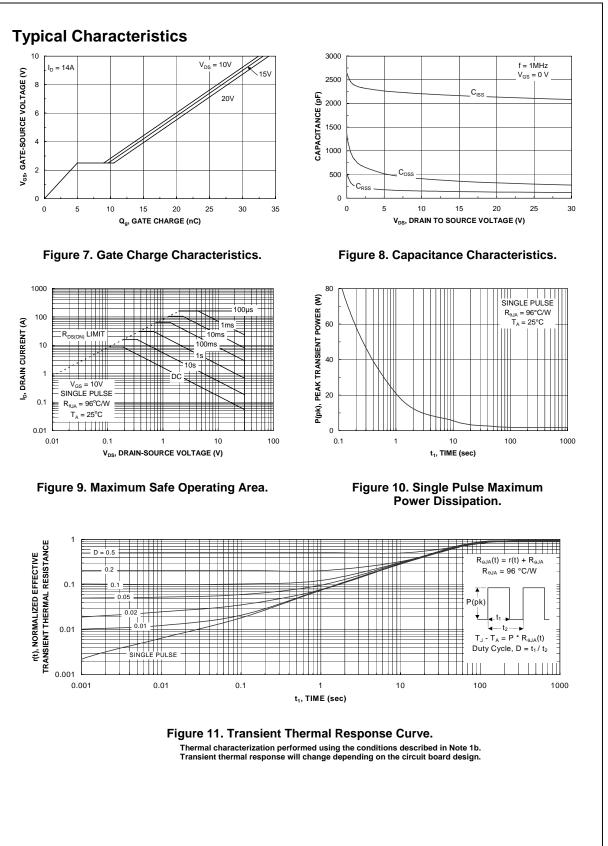
# FDD6692/FDU6692



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FDD/ FDU6692 Rev. C(W)



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